

Applications

- Base Station Transceivers and Repeaters
- Defense Communications
- General Purpose Wireless
- Test Instrumentation
- TDD or FDD systems

Product Features

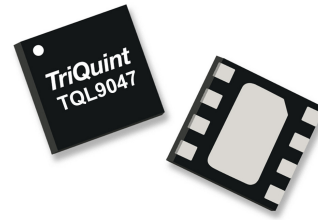
- 50–4000 MHz Operational Bandwidth
- Flat Gain (14.5 ± 1 dB) from 0.7 to 2.7 GHz
- High Linearity, +35.5 dBm Output IP3
- 1.6 dB Noise Figure
- Integrated On-chip Matching, 50 ohm In/Out
- Integrated Active Bias
- Integrated Shutdown Control Pin

General Description

The TQL9047 is a cascadable, high linearity gain block amplifier in a low-cost surface mount package. At 1.9 GHz, the amplifier typically provides 14.5 dB gain, +35.5 dBm OIP3 and 1.6 dB Noise Figure while drawing 70 mA current from a 5V supply.

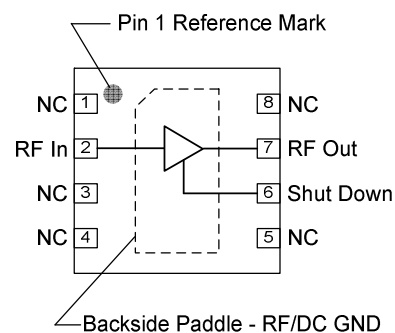
The TQL9047 features medium gain across a broad range of frequencies with the integration of a shut-down biasing capability to allow for operation for TDD applications. The low noise figure and high linearity performance allows the device to be used in both receiver and transmitter chains for high performance systems. The internal active bias circuit also enables stable operation over bias and temperature variations and can be biased from a single positive supply ranging from +3.3 to +5 volts. The amplifier is internally matched using a high performance E-pHEMT process and is housed in a small 2 x 2 mm surface-mount package.

The TQL9047 covers the 700–4000 MHz frequency band and is targeted for wireless infrastructure or other applications requiring high linearity and/or low noise figure.



8 pin 2x2 mm DFN Package

Functional Block Diagram



Pin Configuration

Pin No.	Label
1, 3, 4, 5, 8	NC
2	RF In
6	Shut Down
7	RF Out
Backside Paddle	RF/DC GND

Ordering Information

Part No.	Description
TQL9047	High Linearity Gain Block
TQL9047-PCB_RF	0.5–4.0 GHz Evaluation Board
TQL9047-PCB_IF	50–500 MHz Evaluation Board

Standard T/R size = 2500 pieces on a 7" reel

Absolute Maximum Ratings

Parameter	Rating
Storage Temperature	-65 to 150 °C
Supply Voltage (V_{DD})	+7
RF Input Power, CW, 50Ω, $T=25^{\circ}\text{C}$	20

Operation of this device outside the parameter ranges given above may cause permanent damage.

Recommended Operating Conditions

Parameter	Min	Typ	Max	Units
Supply Voltage (V_{DD})	+3.0	+5.0	+5.25	V
T_{CASE}	-40		+105	°C
T_j for $>10^6$ hours MTTF			+190	°C

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

Electrical Specifications

Test conditions unless otherwise noted: $V_{DD} = +5\text{ V}$, Temp. = $+25^{\circ}\text{C}$, 50 Ω system.

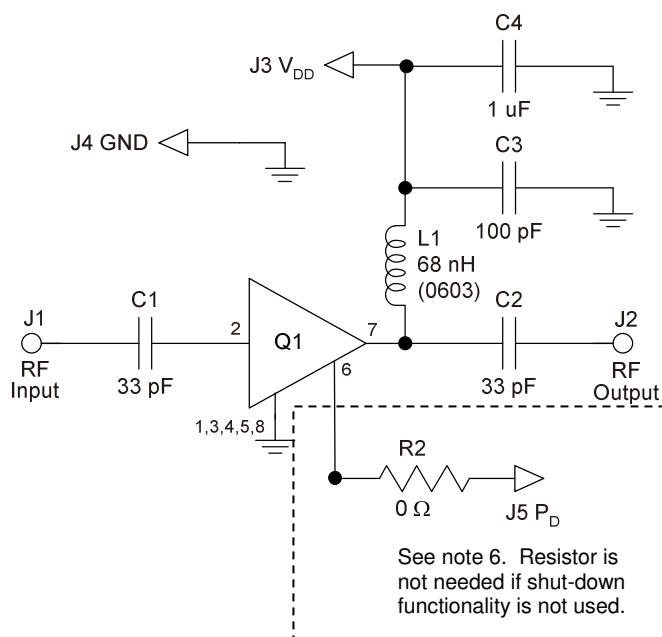
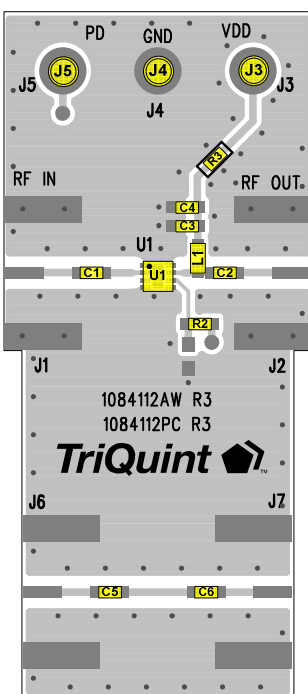
Parameter	Conditions	Min	Typ	Max	Units
Operational Frequency Range		50		4000	MHz
Test Frequency			1900		MHz
Gain		13.0	14.5	16.0	dB
Input Return Loss			11		dB
Output Return Loss			13		dB
Noise Figure			1.6	3.0	dB
Output P1dB		+18	+20.8		dBm
Output IP3	$P_{out} = +4\text{ dBm / tone}$, $\Delta f = 1\text{ MHz}$	+32	+35.5		dBm
Power Shutdown Control (Pin 6)	On state	0		+0.5	V
	Off state (Power down)	+1.4	+3.3	V_{DD}	V
Current, I_{DD}	On state		70	100	mA
	Off state (Power down)		3	5	mA
Shutdown pin current, I_{SD}	$V_{PD} \geq +1.4\text{ V}$		250		μA
Thermal Resistance, θ_{jc}	Channel to case			62	°C/W

S-Parameters

Test Conditions: $V_{DD} = +5\text{ V}$, $I_{DD} = 70\text{ mA (typ.)}$, Temp. = $+25\text{ }^{\circ}\text{C}$, unmatched $50\text{ }\Omega$ system, calibrated to device leads

Freq (GHz)	S11 (dB)	S11 (ang)	S21 (dB)	S21 (ang)	S12 (dB)	S12 (ang)	S22 (dB)	S22 (ang)
0.05	-14.7	-82.4	17.5	163.7	-20.4	10.7	-24.7	-89.6
0.1	-19.4	-117.5	16.9	164.3	-20.0	3.6	-18.2	-156.9
0.2	-22.9	-146.3	16.7	159.8	-19.8	-2.1	-18.6	173.6
0.3	-25.2	-165.5	16.6	153.1	-19.8	-6.1	-19.2	153.6
0.4	-26.5	-174.9	16.5	145.7	-19.7	-9.4	-19.1	137.5
0.5	-29.3	179.8	16.4	138.2	-19.7	-12.5	-19.1	121.5
0.6	-32.8	172.9	16.3	130.7	-19.7	-15.7	-19.5	107.6
0.7	-40.1	-174.1	16.2	123.1	-19.7	-18.7	-19.7	93.5
0.8	-43.3	-61.6	16.1	115.6	-19.6	-21.9	-19.8	78.8
0.9	-33.6	-45.7	16.0	108.1	-19.6	-25.0	-20.0	64.2
1.0	-28.8	-45.4	15.9	100.6	-19.6	-28.3	-20.2	50.0
1.1	-25.7	-48.8	15.8	93.1	-19.6	-31.5	-20.3	35.7
1.2	-23.3	-51.6	15.6	85.7	-19.6	-34.8	-20.3	21.1
1.3	-21.4	-55.3	15.5	78.3	-19.6	-38.1	-20.4	6.1
1.4	-19.9	-59.1	15.4	71.0	-19.6	-41.4	-20.3	-8.8
1.5	-18.7	-63.2	15.3	63.6	-19.6	-44.8	-20.0	-23.9
1.6	-17.6	-67.2	15.2	56.4	-19.6	-48.2	-19.7	-38.4
1.7	-16.7	-71.3	15.1	49.1	-19.6	-51.7	-19.2	-52.2
1.8	-15.9	-75.5	14.9	41.9	-19.7	-55.2	-18.7	-65.6
1.9	-15.3	-79.7	14.8	34.6	-19.7	-58.6	-18.1	-78.2
2.0	-14.7	-84.0	14.7	27.4	-19.7	-62.1	-17.5	-89.8
2.1	-14.2	-88.2	14.6	20.1	-19.8	-65.6	-16.9	-100.9
2.2	-13.8	-92.5	14.5	12.8	-19.8	-69.1	-16.3	-111.1
2.3	-13.5	-96.8	14.4	5.5	-19.8	-72.6	-15.8	-120.8
2.4	-13.2	-101.1	14.3	-1.8	-19.8	-76.2	-15.3	-130.2
2.5	-13.0	-105.5	14.3	-9.2	-19.9	-79.8	-14.8	-138.9
2.6	-12.9	-109.9	14.2	-16.7	-19.9	-83.6	-14.4	-147.7
2.7	-12.8	-114.3	14.1	-24.2	-19.9	-87.2	-13.9	-156.5
2.8	-12.7	-118.6	14.1	-32.0	-19.9	-91.0	-13.6	-165.2
2.9	-12.7	-122.8	14.0	-39.7	-19.9	-94.7	-13.2	-173.9
3.0	-12.7	-126.9	13.9	-47.6	-19.9	-98.7	-13.0	177.1
3.1	-12.7	-130.7	13.8	-55.7	-19.9	-102.7	-12.7	168.1
3.2	-12.8	-134.3	13.8	-64.0	-19.9	-106.8	-12.4	158.8
3.3	-12.9	-137.7	13.7	-72.4	-19.8	-111.0	-12.2	149.4
3.4	-13.0	-140.3	13.6	-81.0	-19.8	-115.4	-12.0	139.8
3.5	-13.0	-142.4	13.5	-89.7	-19.7	-119.9	-11.8	129.8
3.6	-13.0	-143.9	13.3	-98.8	-19.7	-124.7	-11.7	119.6
3.8	-12.8	-144.2	13.0	-117.3	-19.5	-134.7	-11.5	98.0
4.0	-11.8	-143.1	12.5	-136.6	-19.4	-145.8	-11.5	75.3

TQL9047-PCB_RF Evaluation Board



Notes:

1. See Evaluation Board PCB Information section for material and stack-up.
2. R3 (0 Ω jumper) is not shown on the schematic and may be replaced with copper trace in the target application layout.
3. All components are of 0402 size unless stated on the schematic.
4. C1, C2, and C3 are non-critical values. The reactive impedance should be as low as possible at the frequency of operation for optimal performance.
5. The L1 value is non-critical and needs to provide high reactive impedance at the frequency of operation.
6. R2 is optional and does not need to be loaded if the shut-down functionality is not needed; i.e. FDD applications. If R2 is not loaded, the LNA will operate in its standard "ON" state.
7. A through line is included on the evaluation board to de-embed the board losses.

Bill of Material – TQL9047-PCB_RF

Reference Des.	Value	Description	Manuf.	Part Number
N/A	N/A	Printed Circuit Board	TriQuint	N/A
U1	N/A	High Linearity Gain Block	TriQuint	TQL9047
R1	N/A	Do not load	N/A	N/A
R2	0 Ω	Resistor, Chip, 0402, 5%, 1/16W	various	various
R3	0 Ω	Resistor, Chip, 0402, 5%, 1/16W	various	various
L1	68 nH	Inductor, 0603, 5%, Ceramic	various	various
C4	1.0 uF	Cap., Chip, 0402, 10%, 10V, X5R	various	Various
C1, C2, C3, C5, C6	33 pF	Cap., Chip, 0402, 5%, 50V, NPO/COG	various	Various

Typical Performance – TQL9047-PCB_RF

Test conditions unless otherwise noted: $V_{DD} = +5\text{ V}$, $I_{DD} = 70\text{ mA}$ (typ.), Temp. = +25 °C

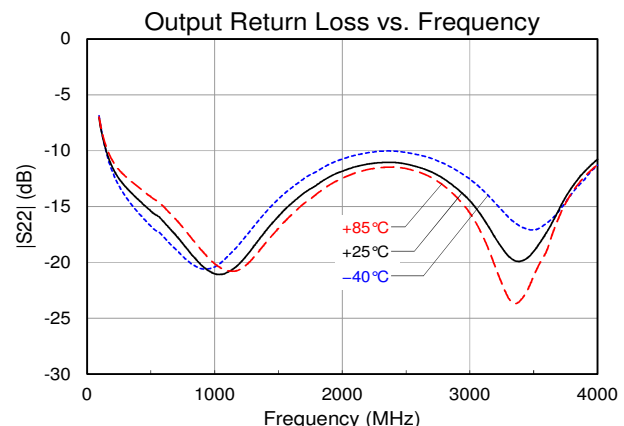
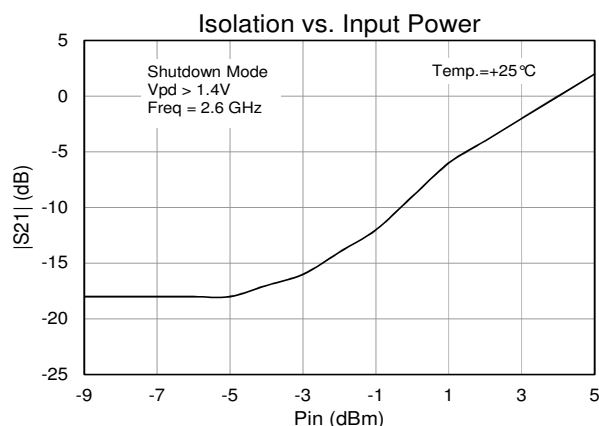
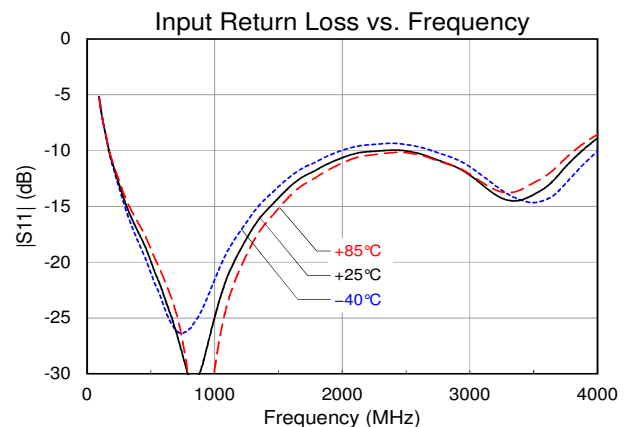
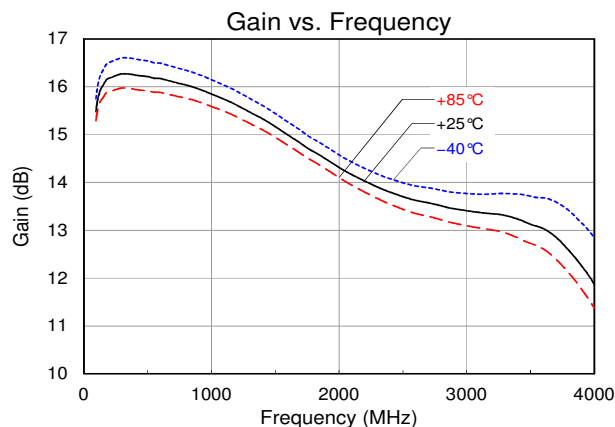
Parameter	Conditions	Typical Values			Units
Frequency		900	1900	2700	MHz
Gain		16	14.5	13.5	dB
Input Return Loss		28	11	10	dB
Output Return Loss		19	13	13	dB
Output P1dB		+21	+20.8	+20.5	dBm
OIP3	Pout = +4 dBm / tone, $\Delta f = 1\text{ MHz}$	+35.8	+35.5	+35.5	dBm
Noise figure ⁽¹⁾		1.5	1.6	1.9	dB

Notes:

- Noise figure data shown in the table above is de-embedded from the eval board loss.

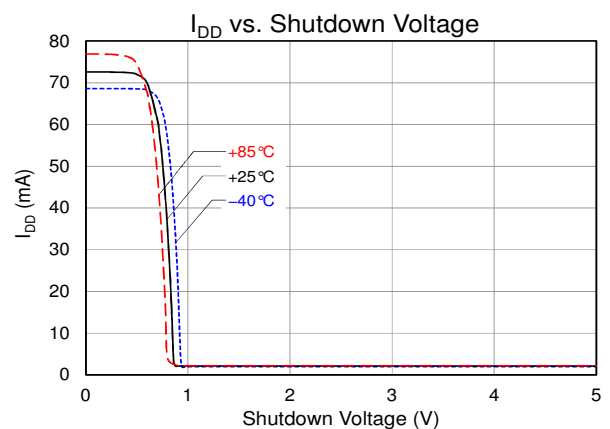
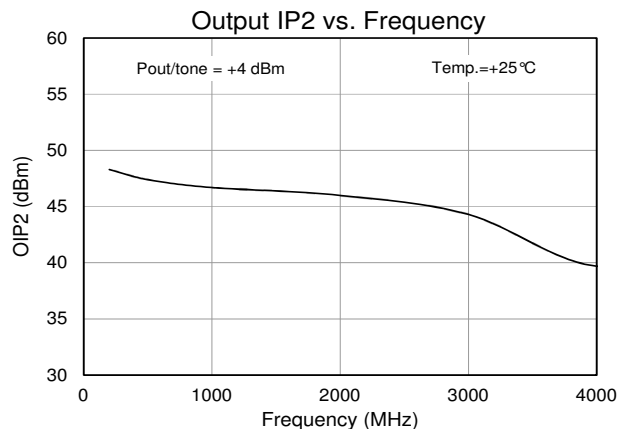
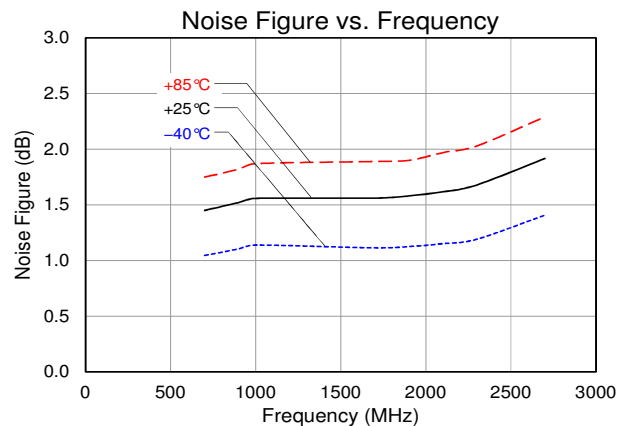
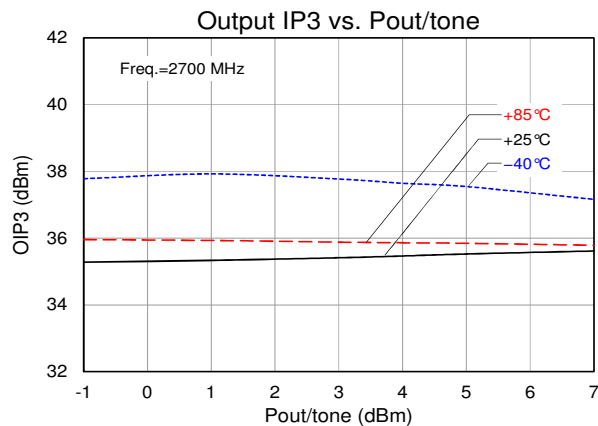
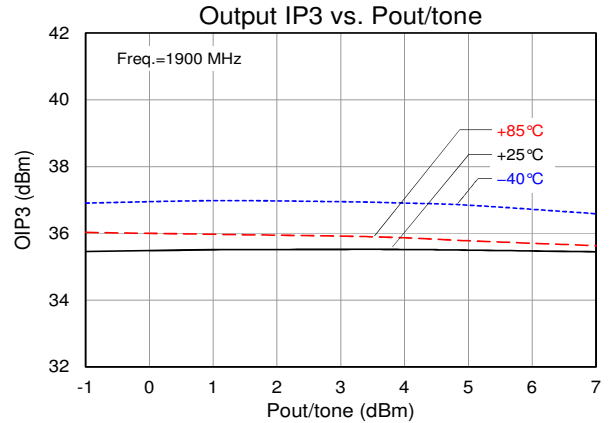
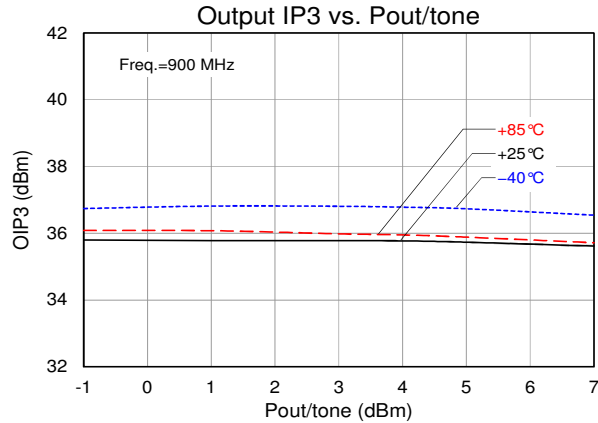
Performance Plots – TQL9047-PCB_RF

Test conditions unless otherwise noted: $V_{DD} = +5\text{ V}$, $I_{DD} = 70\text{ mA}$ (typ.), Temp. = +25 °C



Performance Plots – TQL9047-PCB_RF (cont'd)

Test conditions unless otherwise noted: $V_{DD} = +5\text{ V}$, $I_{DD} = 70\text{ mA}$ (typ.), Temp. = $+25\text{ }^{\circ}\text{C}$



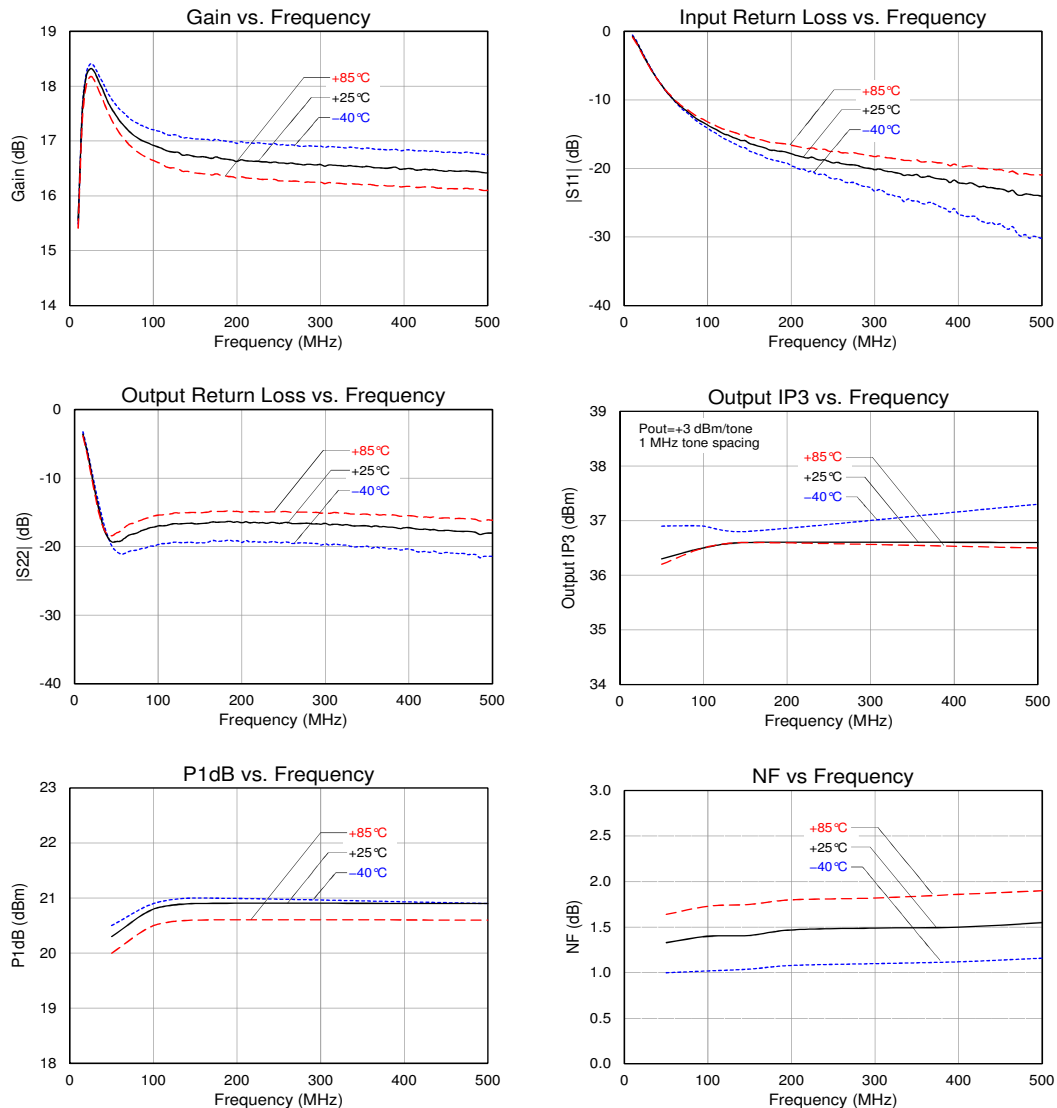
Typical Performance – TQL9047-PCB_IF

Test conditions unless otherwise noted: $V_{DD} = +5\text{ V}$, $I_{DD} = 70\text{ mA}$ (typ.), Temp. = $+25\text{ }^{\circ}\text{C}$, C1 and C2 = 1000 pF, L1 = 330 nH

Parameter	Conditions	Typical Values				Units
Frequency		50	100	150	500	MHz
Gain		17.5	17	16.7	16.4	dB
Input Return Loss		8	13	16	23	dB
Output Return Loss		18	17	17	18	dB
Output P1dB		+20.4	+20.7	+20.8	+20.8	dBm
OIP3	Pout = +3 dBm / tone, $\Delta f = 1\text{ MHz}$	+36.3	+36.4	+36.5	+36.5	dBm
Noise Figure ⁽¹⁾	Eval board losses de-embedded	1.4	1.4	1.4	1.6	dB

Performance Plots – TQL9047-PCB_IF

Test conditions unless otherwise noted: $V_{DD} = +5\text{ V}$, $I_{DD} = 70\text{ mA}$ (typ.), Temp. = $+25\text{ }^{\circ}\text{C}$, C1 and C2 = 1000 pF, L1 = 330 nH



Typical Performance – TQL9047-PCB_RF $V_{DD} = +3.3V$

Test conditions unless otherwise noted: $V_{DD} = +3.3V$, $I_{DD} = 42$ mA (typ.), Temp = +25 °C

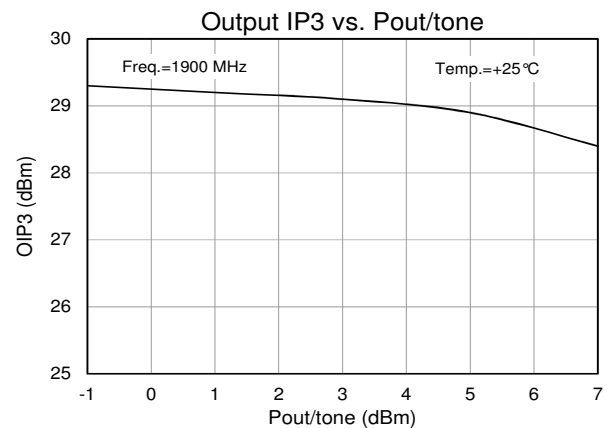
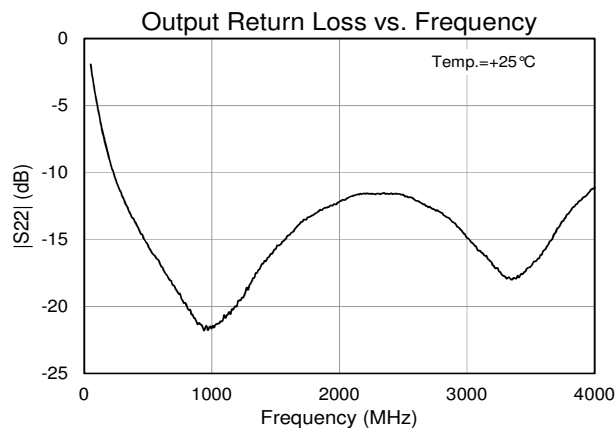
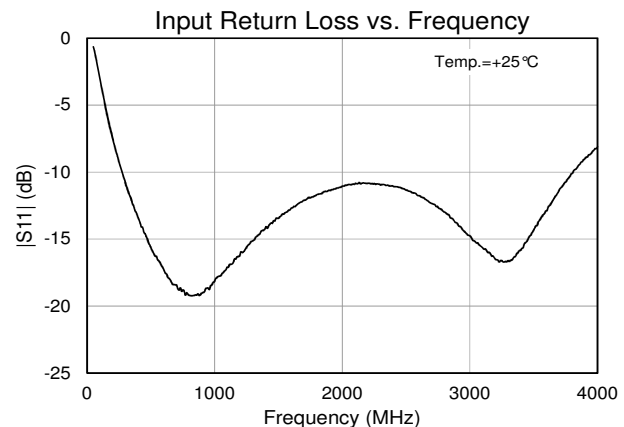
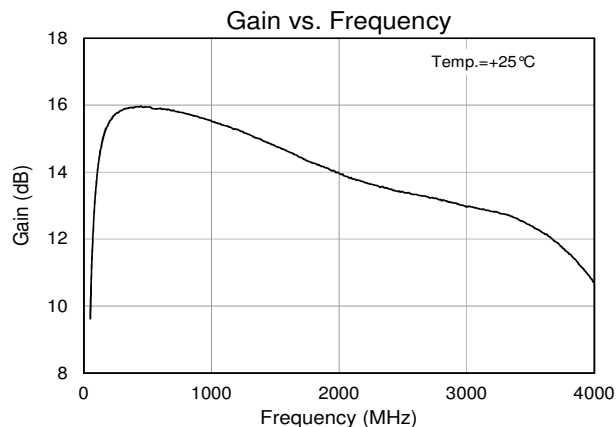
Parameter	Conditions	Typical Values	Units
Frequency		1900	MHz
Gain		14.0	dB
Input Return Loss		11	dB
Output Return Loss		12.5	dB
Output P1dB		+16.7	dBm
OIP3	Pout = +3 dBm / tone, $\Delta f = 1$ MHz	+29	dBm
Noise figure ⁽¹⁾		1.7	dB

Notes:

- Noise figure data shown in the table above is de-embedded from the eval board loss.

Performance Plots – TQL9047-PCB_RF $V_{DD} = +3.3V$

Test conditions unless otherwise noted: $V_{DD} = +3.3V$, $I_{DD} = 42$ mA (typ.), Temp = +25 °C

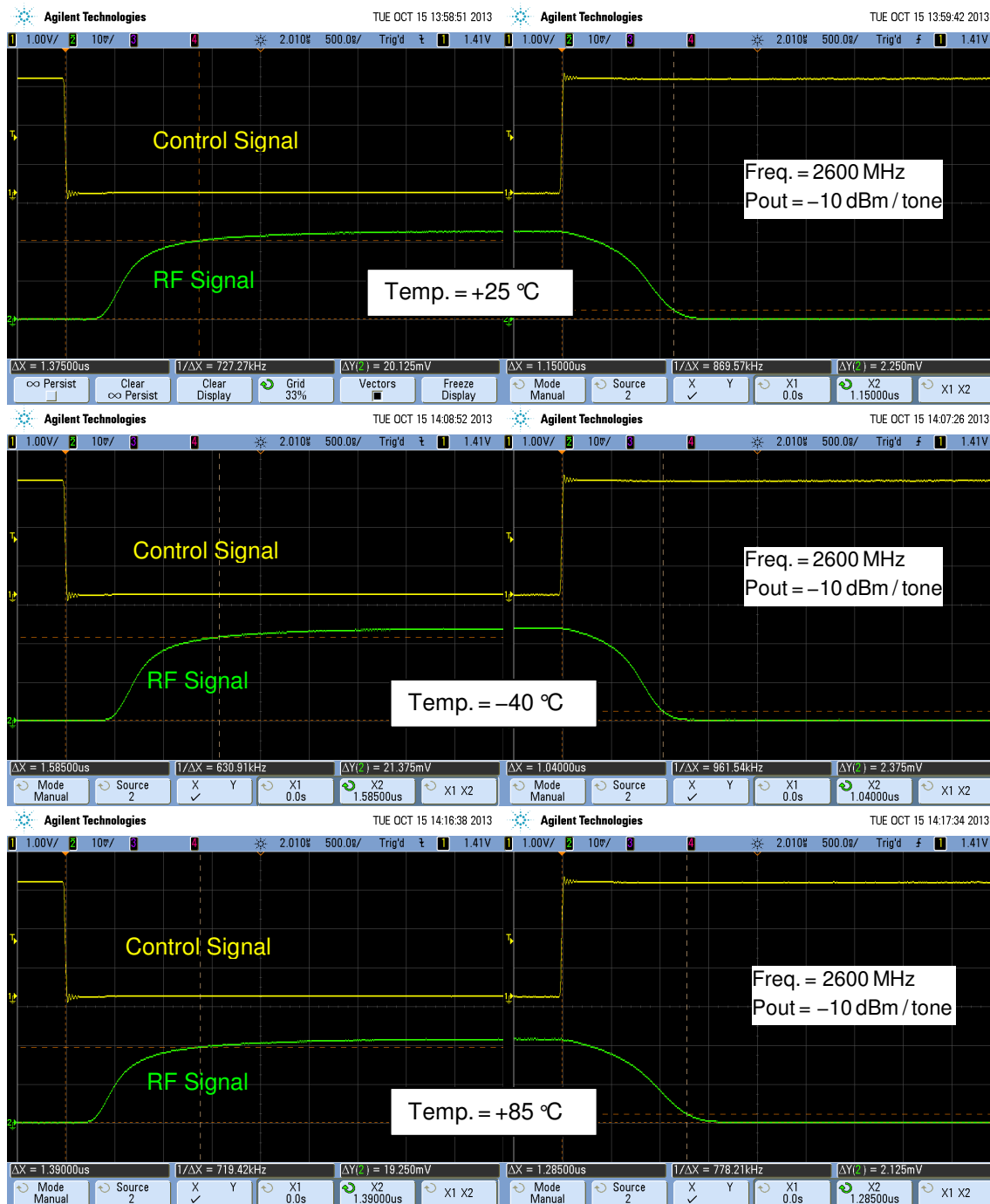


Switching Speed

Switching Speed Measurement based on TQS Application Board

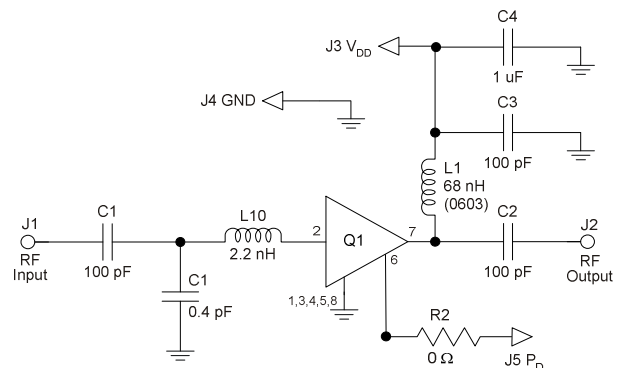
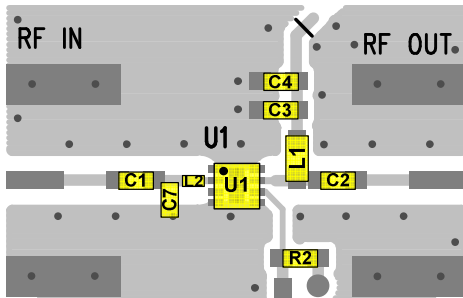
Using Shutdown Circuit: $V_{PD} = +3V$, $V_{DD} = +5V$

Parameter	-40 °C	+25 °C	+85 °C
Turn-off Transition (50% CNTR – 10% RF)	1.04 μs	1.15 μs	1.28 μs
Turn-on Transition (50% CNTR – 90% RF)	1.58 μs	1.37 μs	1.39 μs



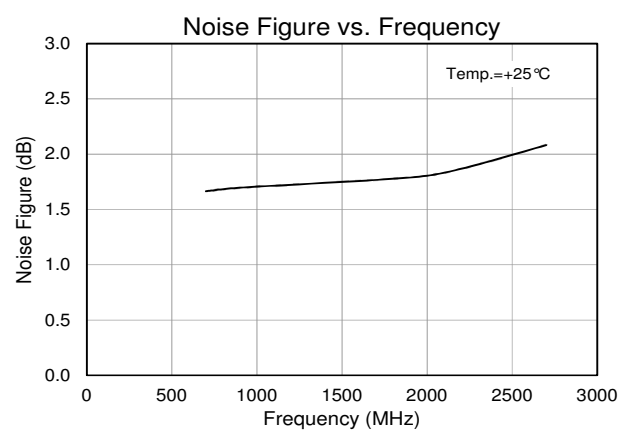
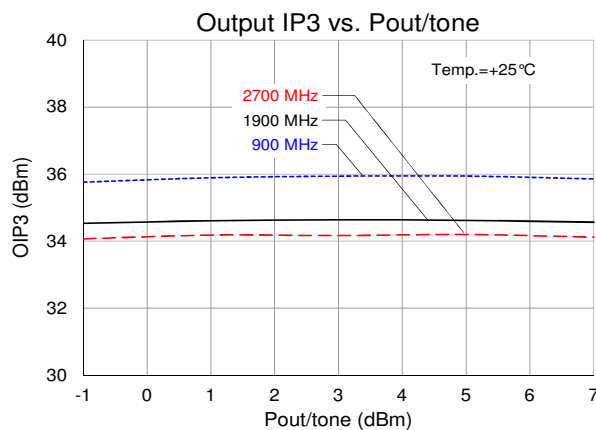
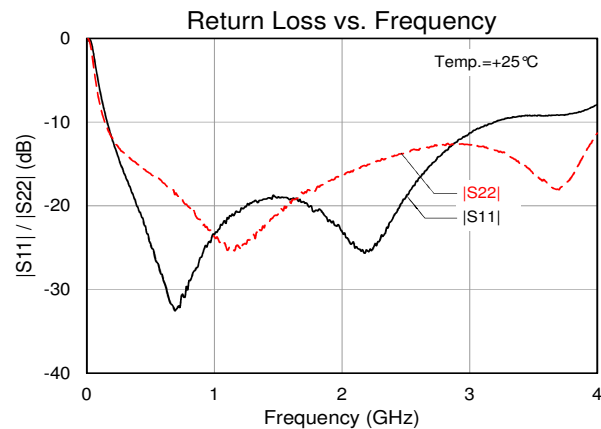
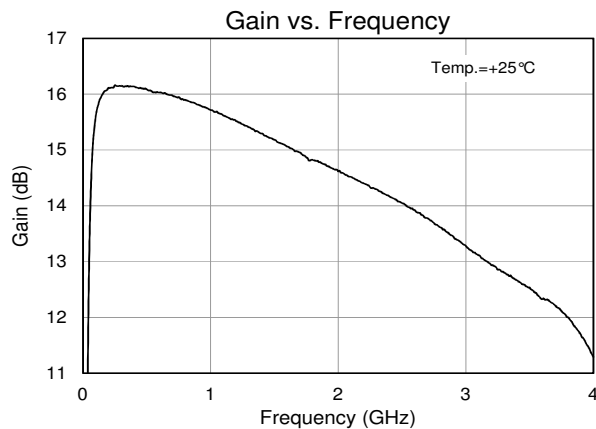
Reference Design – Optimized Return Loss

Input return loss over the 500 – 2700 MHz band can be optimized using a 2 element input tune.

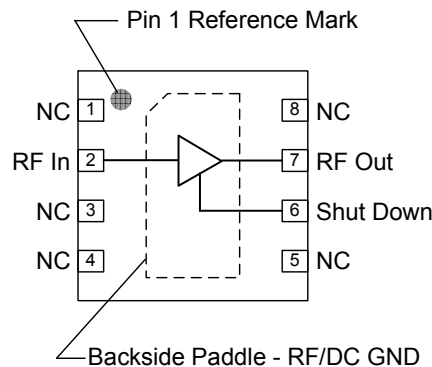


Performance Plots

Test conditions unless otherwise noted: $V_{DD} = +5V$, $I_{DD} = 70\text{ mA (typ.)}$, Temp. = +25 °C



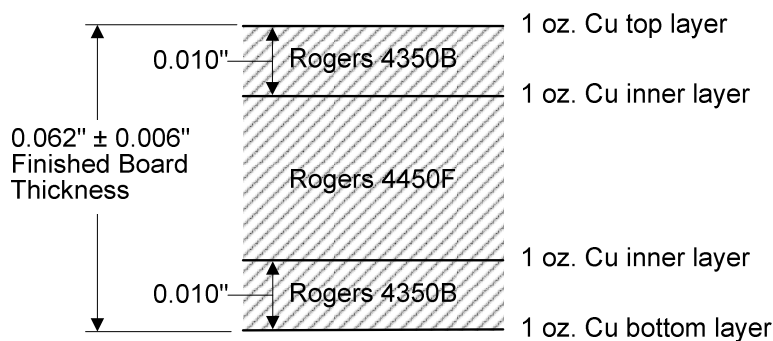
Pin Configuration and Description



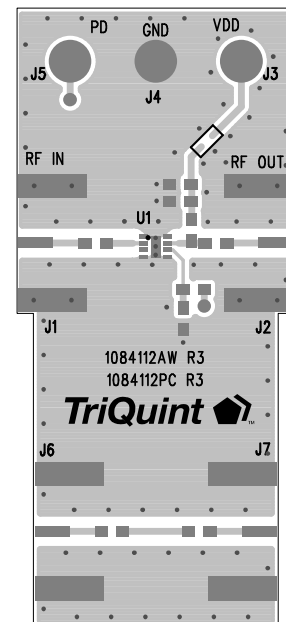
Pin No.	Label	Description
2	RF In	RF Input pin. A DC Block is required.
6	Shut Down	A high voltage turns off the device. If the pin is not connected or is less than 0.5V, then the device will operate under its normal operating condition.
7	RF Out	RF Output pin. DC bias will also need to be injected through a RF bias choke/inductor for operation.
1, 3, 4, 5, 8	NC	No electrical connection. Provide grounded land pads for PCB mounting integrity.
Backside Paddle	RF/DC GND	RF/DC ground. Use recommended via pattern to minimize inductance and thermal resistance; see PCB Mounting Pattern for suggested footprint.

Evaluation Board PCB Information

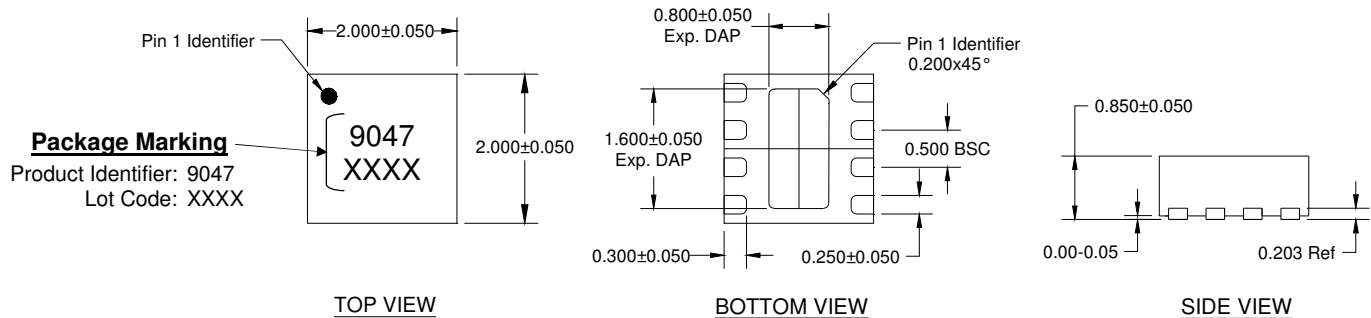
TriQuint PCB 1084112 Material and Stack-up



50 ohm line dimensions: width = 0.020", spacing = 0.032"



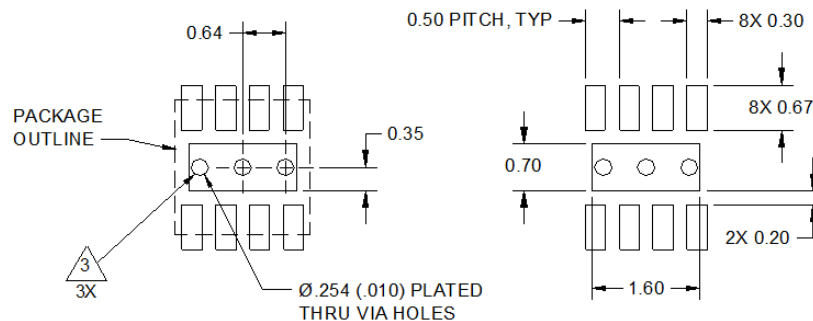
Package Marking and Dimensions



Notes:

1. All dimensions are in millimeters. Angles are in degrees.
2. Except where noted, this part outline conforms to JEDEC standard MO-229.
3. Dimension and tolerance formats conform to ASME Y14.4M-1994.
4. The terminal #1 identifier and terminal numbering conform to JESD 95-1 SPP-012.

PCB Mounting Pattern



Notes:

1. All dimensions are in millimeters. Angles are in degrees.
2. Use 1 oz. copper minimum for top and bottom layer metal.
3. Vias are required under the backside paddle of this device for proper RF/DC grounding and thermal dissipation. We recommend a 0.35mm (#80/.0135") diameter bit for drilling via holes and a final plated thru diameter of 0.25 mm (0.10").
4. Ensure good package backside paddle solder attach for reliable operation and best electrical performance.

Product Compliance Information

ESD Sensitivity Ratings



Caution! ESD-Sensitive Device

ESD Rating: Class 1A
Value: ≥ 250 V to < 500 V
Test: Human Body Model (HBM)
Standard: ESDA/JEDEC Standard JS-001-2012

ESD Rating: Class C3
Value: ≥ 1000 V to < 2000 V
Test: Charged Device Model (CDM)
Standard: JEDEC Standard JESD22-C101

MSL Rating

MSL Rating: Level 1
Test: 260 °C convection reflow
Standard: JEDEC Standard IPC/JEDEC J-STD-020

Solderability

Compatible with both lead-free (260 °C max. reflow temperature) and tin/lead (245 °C max. reflow temperature) soldering processes.

Contact plating: NiPdAu

RoHS Compliance

This part is compliant with EU 2002/95/EC RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A ($C_{15}H_{12}Br_4O_2$) Free
- PFOS Free
- SVHC Free

Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations, and information about TriQuint:

Web: www.triquint.com
Email: info-sales@triquint.com

Tel: +1.503.615.9000
Fax: +1.503.615.8902

For technical questions and application information:

Email: sjcapapplications.engineering@triquint.com

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